

BCP53

Rev.E Mar.-2016

/ Descriptions

SOT-223 PNP Silicon PNP transistor in a SOT-223 Plastic Package.

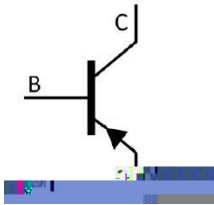
/ Features

High current,Low voltage.

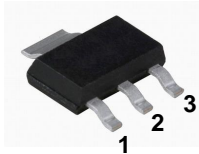
/ Applications

Medium Power Switching or Amplification Applications .

/ Equivalent Circuit



/ Pinning



PIN1 Base PIN 2 Collector PIN 3 Emitter

/ h_{FE} Classifications & Marking

h_{FE} Classifications Symbol	10	16
h_{FE} Range	63~160	100~250

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Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-100	V
Collector to Emitter Voltage	V_{CEO}	-80	V
Emitter to Base Voltage	V_{EBO}	-5.0	V
Collector Current - Continuous	I_C	-1.0	A
Peak Pul[O9e 1 Tf6.38.00004 D-8(A)tin)-502 0ous		IC	

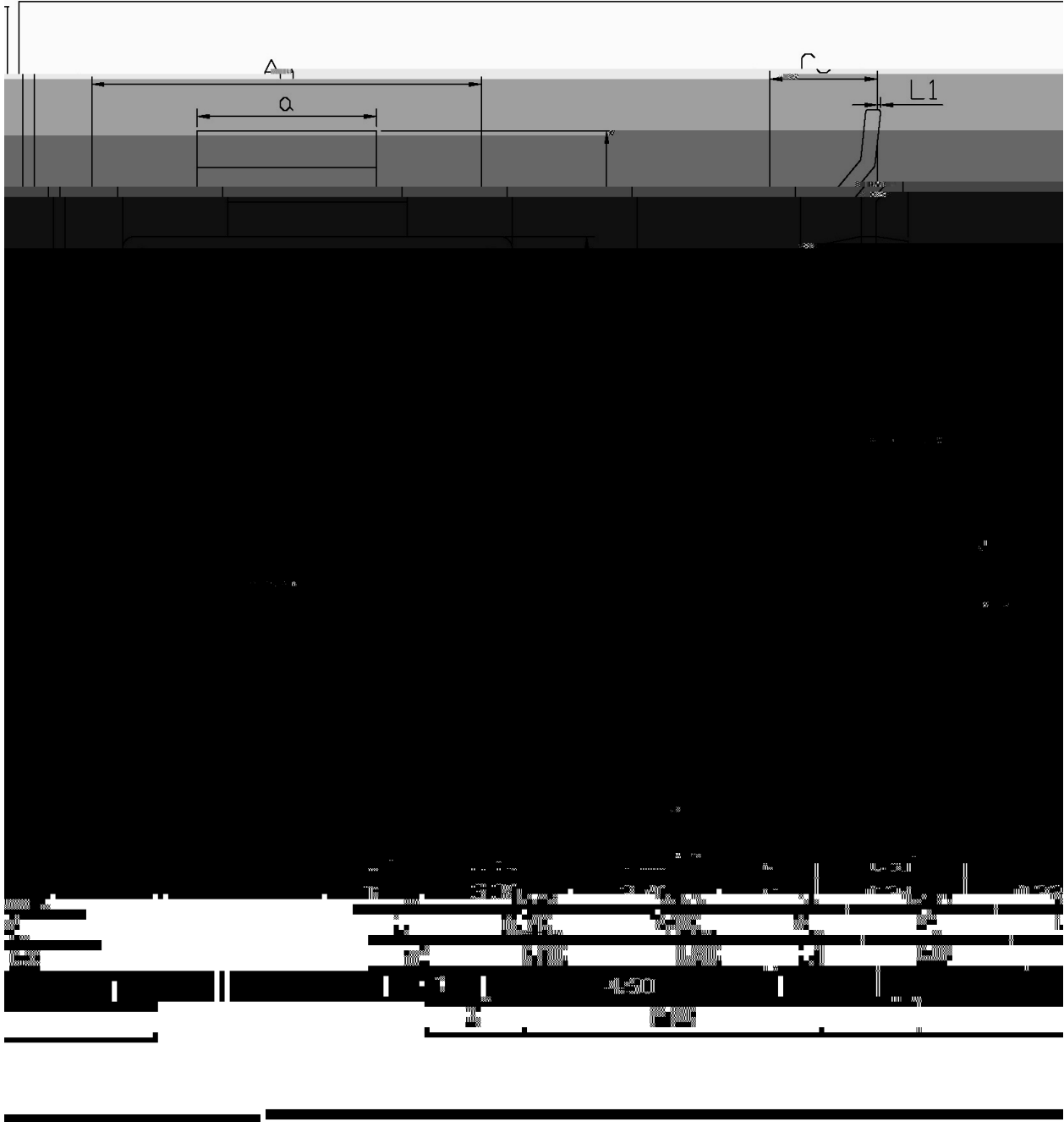
/ Electrical Characteristic Curve



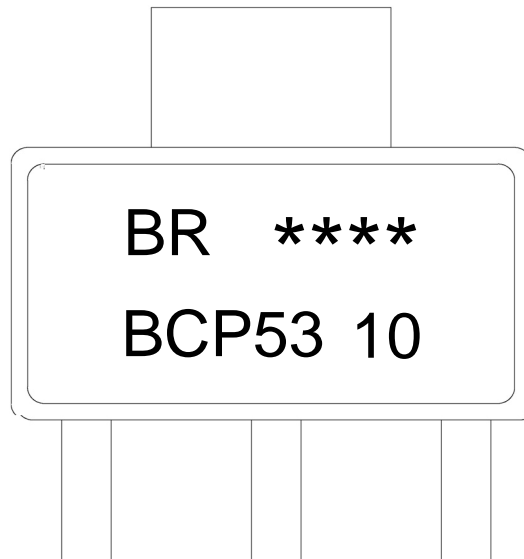
/ Package Dimensions

SOT-223

单位: mm



/ Marking Instructions



BR

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10

h_{FE}

Note:

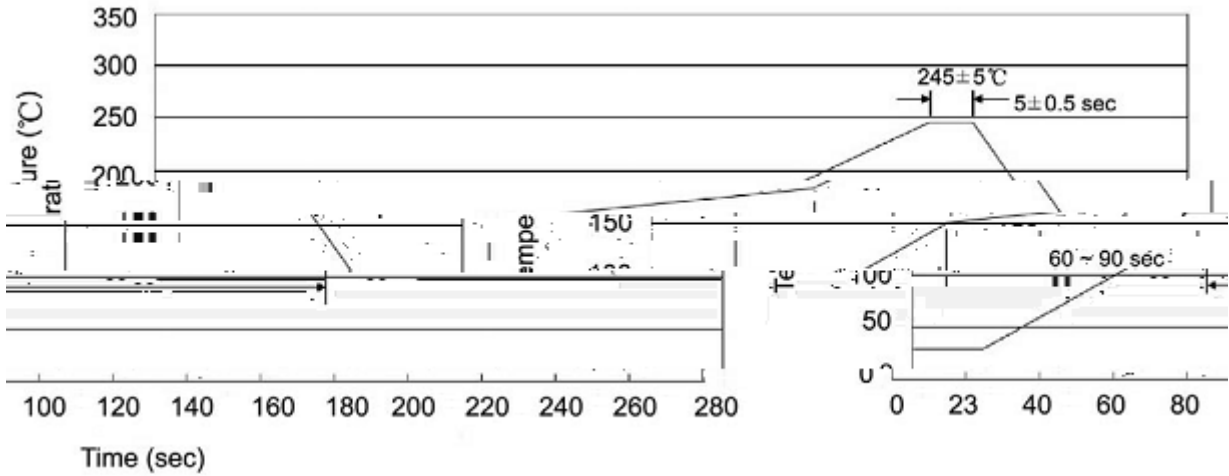
BR: Company Code.

BCP53: Product Type.

10: h_{FE} Classifications Symbol

****: Lot No. Code, code change with Lot No.

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-------|-----|----|-----------|---|
| 1 | 25 | 150 | 60 | 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 245±5 | | | 5±0.5sec; | 2.Peak Temp.:245±5 , Duration:5±0.5sec. |
| 3 | | | 2 | 10 /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

260±5 10±1 sec. Temp:260±5 Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-223	2,500	2	5000	5	25,000	13 ×12	340×340×50	385×257×392

/ Notices